

Docket No. 618902001410
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Chun H. FAN et al.

Application No. 10/681,983

Confirmation No. 8846

Filed: October 9, 2003

Art Unit: 2826

For: MULTIPLE LEADFRAME LAMINATED IC
PACKAGE

Examiner: Leonardo Andujar

AMENDMENT UNDER 37 CFR 1.111

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated January 28, 2008, please amend this application as follows.

Amendments to the claims begin on page 2.

Remarks begin on page 4.